TYPE WC 2.5X2.0 VOLTAGE CONTROLLED TEMPERATURE COMPENSATED CRYSTAL OSCILLATOR

WC2551I0016.369000 VER. 03 16-Apr-13

ELECTRICAL SPECIFICATIONS

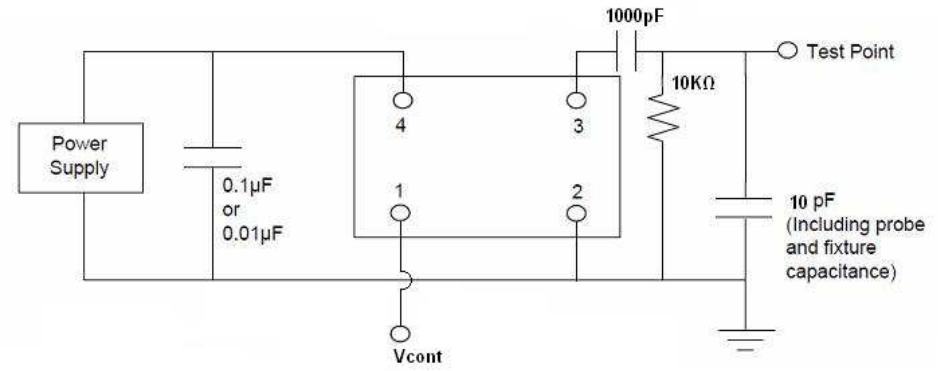
SRe Part Number : WC2551I0016.369000

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fo	16.369000	MHz	
Operating Temperature Range	TR	-30 to +85	°C	
Storage Temperature Range		-40 to +85	°C	
Supply Voltage	V_{DD}	+3.3 ± 5.0%	V	
Frequency Stability	FT	± 2.0	ppm	vs. Temperature (Refer to the mid-point between minimum and maximum frequency values over the specified temperature range)
Frequency Stability		± 0.2	ppm	vs. Load varied 10pF//10kΩ±10%
Frequency Stability		± 0.1	ppm	vs. Supply Voltage varied Vdd±5% at 25°C
Frequency Tolerance		± 2.0	ppm	Max. After 2 times reflow (Refer to nominal frequency)
Static Temperature Hysteresis		± 0.6	ppm	Max.
Aging		±1	ppm	per year at 25°C
Logic Type	LT	Clipped Sinewave		
Supply Current	I_{DD}	1.5	mA	Max.
Start Up Time v.s Output Level		2.5	msec	Max, 90% of specified output level
Output Voltage		0.8 to 1.4	Vp-p	
Output Load Resistance		10	KΩ	9KΩ Min / 11KΩ Max
Output Load Capacitance		10	pF	9pF Min / 11pF Max
Harmonics		-7	dBc	Max.
Phase Noise		-134	dBc/Hz	Max, at 1kHz offset
Frequency Control Range		±5 to ±15	ppm	Vcont=0.65V to 2.65V
Linearity		10	%	Max
Input Resistance		500	KΩ	Min
Modulation Bandwidth		10	KHz	Min

※ This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

PERICOM SaRonix-eCera

TEST CIRCUIT



RELIABILITY SPECIFICATIONS

ENVIRONMENTAL:

a) THERMAL SHOCK: MIL-STD-883, Method 1011, Condition A

b) MOISTURE RESISTANCE: MIL-STD-883, Method 1004

c) VIBRATION: MIL-STD-883, Method 2007, Condition A

d) RESISTANCE TO SOLDERING HEAT: J-STD-020D Table 5-2 Pb-free devices (except 2 cycles max)

e) HAZARDOUS SUBSTANCE: Pb - free and RoHS Compliant.

MECHANICAL:

a) SHOCK: MIL-STD-883, Method 2002, Condition B

b) SOLDERABILITY: JESD22-B102-D Method 2 (Preconditioning E)

c) TERMINAL STRENGTH: MIL-STD-883, Method 2004, Test Condition D

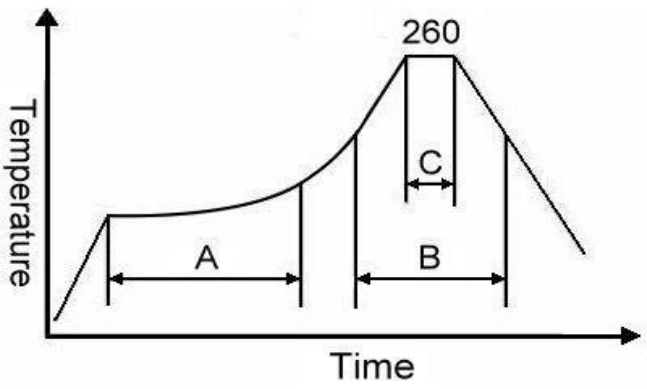
d) GROSS LEAK: MIL-STD-883, Method 1014, Condition C

e) FINE LEAK: MIL-STD-883, Method 1014, Condition A2, R1=2x10^{-8} atm cc/s

f) SOLVENT RESISTANCE: MIL-STD-202, Method 215

SUGGESTED IR REFLOW PROFILE

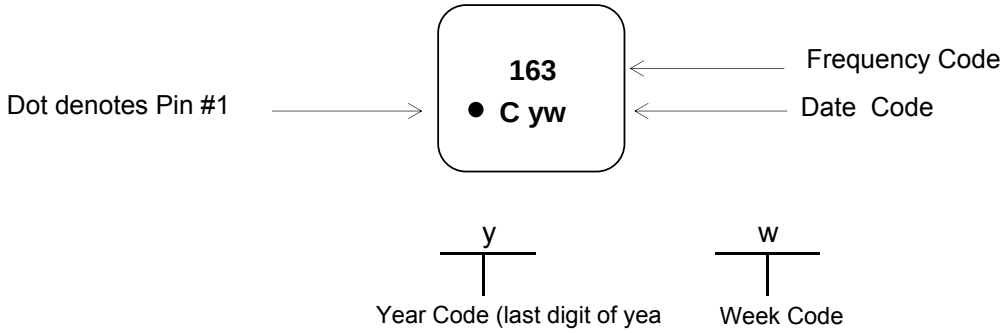
*As per IPC-JEDEC J-STD-020D



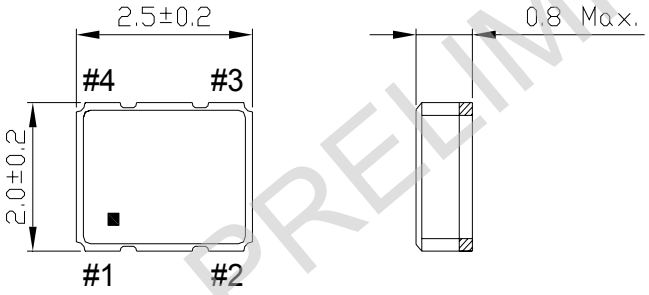
Note:

	Stage	Temperature	Time
A	Preheat	150~200°C	60~120 Sec
B	Primary Heat	217°C	60~150 Sec
C	Peak	260°C	10 Sec

MARKING

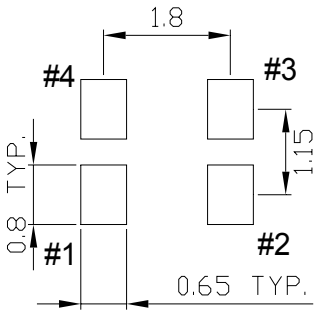


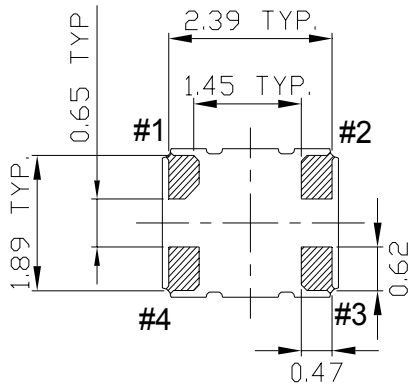
MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)



Recommended Land Pattern

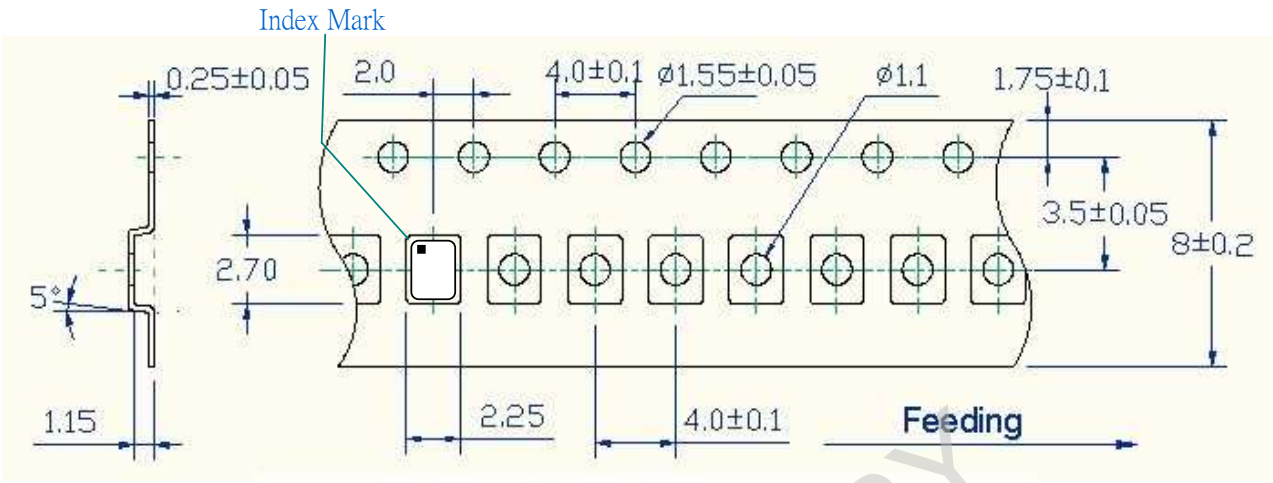
(TOP VIEW)

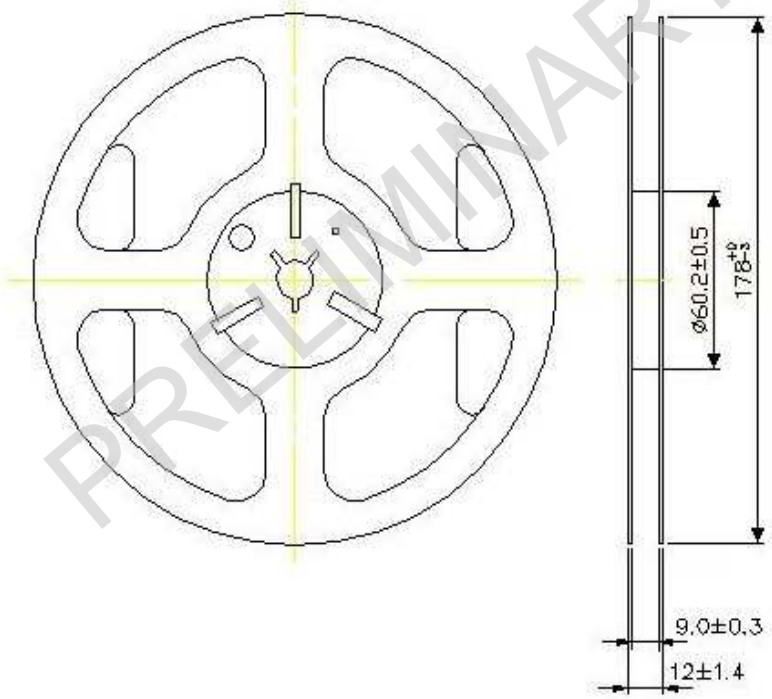




Pin No.	Connections
1	Vcont
2	GND
3	OUTPUT
4	V_{DD}

TAPE&REEL





1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

PACKING